

## Declaration of Conformity on RoHS/China RoHS

Revision: August 2024

The following following Declaration of Conformity applies to all unassembled printed circuit boards produced by the KSG Group. In accordance with EU Directive 2011/65/EU and amendments 2015/863/EU and 2017/2102/EU, the following restricted materials are not used in our products above the compulsory weight limit:

- Mercury (0.1 %)
- Lead (0.1 %)
- Cadmium (0.01 %)
- Hexavalent chromium (0.1 %)
- Polybrominated biphenyls (PBB) (0.1 %)
- Polybrominated diphenyl ethers (PBDE) (e.g. pentaBDE and octaBDE) (0.1 %)
- Phthalates DEHP, BBP, DBP, DIBP (0.1 %)

A restriction applies to the use of lead where printed circuit boards are explicitly ordered with a leaded HAL (hot air levelling) solder surface.

The final product only conforms to EU Directive 2011/65/EU if the customer have a valid exemption for the end product.

Of course, we have RoHS-compliant solder surfaces available in-house as an alternative.

This statement also applies in respect of China-RoHS 2 and Directive 2012/19/EU (WEEE).

KSG regularly monitors the above directives for updates and amends its declarations as necessary.

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